

TPS65987 Evaluation Module

This document is the user guide for the TPS65987 Evaluation Module (TPS65987EVM). The TPS65987EVM allows for evaluation of the TPS65987 IC as part of a stand-alone testing kit for development and testing of USB Type-C and Power Delivery (PD) end products. Out of the box, the TPS65987EVM is configured to emulate a single port laptop computer. The TP65987EVM also contains a TPD6S300A device for protection.

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Trademarks

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1 Introduction

Texas Instrument's (TI's) TPS65987 evaluation module helps designers evaluate the operation and performance of the TPS65987 device.

The TPS65987 device is a USB Type-C and Power Delivery (PD) controller providing cable plug and orientation detection at the USB Type-C connector. Upon cable detection, the TPS65987 communicates on the CC wire using the USB PD protocol. When cable detection and USB PD negotiation are complete, the TPS65987 device enables the appropriate power path and configures Alternate Mode settings for external multiplexers. The TPS65987D device has two internal power paths that can be source or sink with current rating up to 5 A. The EVM is customizable through the TPS65987 Application Customization Tool. Additionally, the EVM is equipped with an FTDI chip for flashing a new project through SPI or I2C for debugging and development.

Figure 1 shows the TPS65987EVM board and Figure 2 shows a block level diagram.

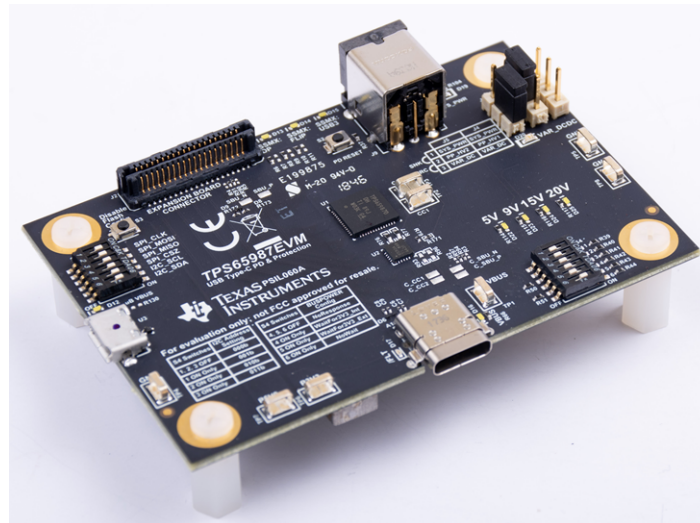


Figure 1. TPS65987EVM Board

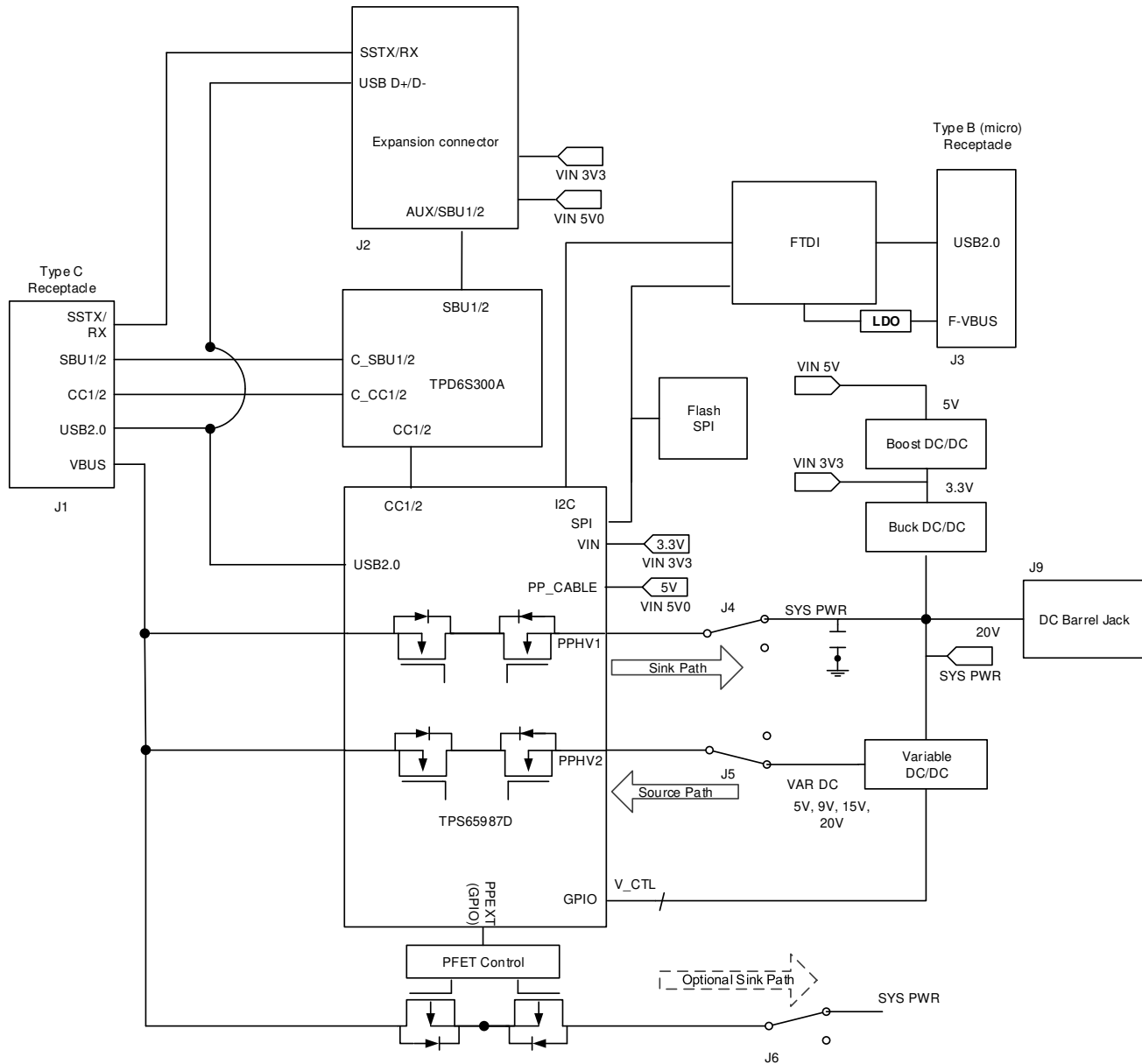


Figure 2. TPS65987EVM Block Level Diagram

1.1 Items Required for Operation

The following is required to operate the EVM:

- TPS65987EVM
- 20-V barrel jack adapter or dc power supply
- Active or e-marked USB Type-C cables
- USB Type-A to USB Micro-B cable (for configuration customization, debugging and updating FW flash)
- [TPS65987D USB Type-C and USB PD Controller with Integrated Power Switches](#) data sheet
- [TPS6598x configuration tool](#)
- [TPS6598x Application Customization Tool](#) user's guide
- [How to evaluate and configure TI's USB type-C PD Controllers](#) training videos

2 Setup

This section describes the header and jumper connections on the EVM and getting started using the TPS65987EVM.

2.1 Jumper Configuration

Out of the box, the TPS65987EVM is configured to use TPS65987's PPHV1 as sink path (J4) and PPHV2 as source path (J5), which matches the configuration of firmware already programmed in the device. Recovery FW can be programmed using the Application customization tool. In order to do that open the Application customization tool, go to File menu Device/Re Flash EVM Firmware (recovery), and select EVM Recovery File tps65987_evm_flash_image.bin.

Remember, the jumper configuration in the hardware must match the source and sink paths in the software, *Application Customization Tool (GUI)*. See [Figure 3](#) and [Table 1](#) for the jumper configuration.

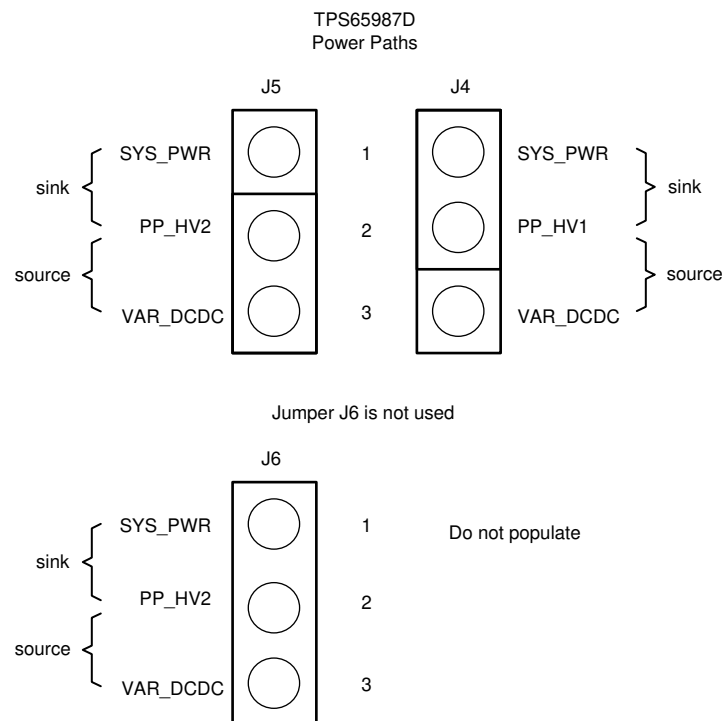


Figure 3. Power Path Jumper Configuration for Source or Sink

Table 1. Jumper Configuration

| Jumper | Description |
|--------|---|
| J4 | TPS65987D power path: Jump pins 1-2 to sink on PP_HV1 (default) |
| J5 | TPS65987D power path: Jump pins 2-3 to source on PP_HV2 (default) |

2.2 Connector Functionality

Table 2 lists the TPS65987EVM connector and functionality.

Table 2. Connector Functionality

| Designator | Description |
|------------|--|
| J1 | USB Type-C connector: TI recommends using an active or e-marked USB Type-c cable |
| J2 | Expansion board connector: Option to connect to external module. |
| J3 | Micro-B connector: Connect to a PC to flash a project on the PD controller. You must download the TPS6598x configuration tool (GUI) to flash a project properly. |
| J9 | Barrel jack connector: Use a 19-V to 20-V DC supply. A standard Dell or HP notebook adapter (or similar) will provide the required power. |

2.3 Test Points

Table 3 lists the TPS65987EVM test points.

Table 3. Test Points

| Test Point | Label | Description |
|---------------|-------|--|
| TP1 | VBUS | V_{BUS} voltage on the USB Type-C connector. Sourcing and sinking is always in reference to V_{BUS} (Source to V_{BUS} or sink from V_{BUS}). |
| TP2 | CC1 | System side CC1. This could be VCONN or CC depending on polarity flip of the USB Type-C cable. |
| TP3 | CC2 | System side CC2. This could be VCONN or CC depending on polarity flip of the USB Type-C cable. |
| TP4, TP5, TP8 | GND | Ground reference for entire board |
| TP6 | P3V3 | Output of 3.3-V DC/DC convertor to power up all ICs on the EVM |
| TP7 | P5V0 | Output of 5-V DC/DC convertor used for PP_CABLE (VCONN) |

2.4 LEDs

Table 4 lists the TPS65987EVM LEDs.

Table 4. LEDs

| Designator | Label | Description |
|------------|--------------|--|
| D12 | μ B VBUS | White LED that shows when the μ B port is connected (FTDI for GUI). |
| D13 | SSMX: DP | White LED that shows when the TPS65987D device has enabled this signal for external module super-speed MUX (depending on version of EVM the silkscreen may appear to show this signal swapped with SSMX: USB3) |
| D14 | SSMX: FLIP | White LED that shows when the TPS65987D device has enabled this signal for external module super-speed MUX |
| D15 | SSMX: USB3 | White LED that shows when the TPS65987D device has enabled this signal for external module super-speed MUX |
| D16 | VBUS | White LED that shows when V_{BUS} has a voltage of 5 V, 9 V, 15 V, or 20 V |
| D19 | SYS_PWR | Blue LED that shows when the barrel jack is connected |
| D20 | VAR_DCDC | Green LED that shows when there is a voltage on the variable DC/DC controller (U9). When the EVM acts as a source, D20 lights up. |
| D22 | PDO_0 | White LED that shows when there is a 5-V PD contract (only shown when sourcing) |
| D22 | PDO_1 | White LED that shows when there is a 9-V PD contract (only shown when sourcing) |
| D24 | PDO_2 | White LED that shows when there is a 15-V PD contract (only shown when sourcing) |
| D25 | PDO_3 | White LED that shows when there is a 20-V PD contract (only shown when sourcing) |
| D17 | /FLT | Red LED that shows when there is a fault occurred TPD6S300A device |

2.5 Switches

Table 5, Table 6, and Table 7 lists the TPS65987EVM switches. For S1, make sure to leave all six switches in the ON position (to the right) for flashing a project and debugging. For S4 Switch: EVM out of the box should have S4->4 (BP_WaitFor3V3_Internal) as on(right). This ensures that PD controller enables internal paths in dead battery mode. This switch can be turned off(left) if EVM is used as source only. Note, S4[1, 2, 3] only one switch should be in "ON" position at a time, same way for S4[4, 5, 6].

Table 5. S1 Switch Bank

| Switch (S1) | Description |
|-------------|--|
| 1: SPI_CLK | Connects SPI_CLK node from FTDI to TPS65987D, EEPROM when the switch is in the ON position (to the right), and disconnects when in the OFF position (to the left) |
| 2: SPI_MOSI | Connects SPI_MOSI node from FTDI to TPS65987D, EEPROM when the switch is in the ON position (to the right), and disconnects when in the OFF position (to the left) |
| 3: SPI_MISO | Connects SPI_MISO node from FTDI to TPS65987D, EEPROM when the switch is in the ON position (to the right), and disconnects when in the OFF position (to the left) |
| 4: SPI_CSZ | Connects SPI_CSZ node from FTDI to TPS65987D, EEPROM when the switch is in the ON position (to the right), and disconnects when in the OFF position (to the left) |
| 5: I2C_SCL | Connects I2C_SCL node from FTDI to TPS65987D, EEPROM when the switch is in the ON position (to the right), and disconnects when in the OFF position (to the left) |
| 6: I2C_SDA | Connects I2C_SDA node from FTDI to TPS65987D, EEPROM when the switch is in the ON position (to the right), and disconnects when in the OFF position (to the left) |

Table 6. S4 Switch Bank

| Switch (S4) | Description |
|-------------|---|
| 1, 2, 3 OFF | I2C address selection: 000b |
| 1 ON Only | I2C address selection: 001b |
| 2 ON Only | I2C address selection: 010b |
| 3 ON Only | I2C address selection: 011b |
| 4, 5, 6 OFF | Dead battery mode: BP_NoResponse |
| 4 ON Only | Dead battery mode: BP_WaitFor3V3_Internal |
| 5 ON Only | Dead battery mode: BP_WaitFor3V3_External |
| 6 ON Only | Dead battery mode: BP_NoWait |

Table 7. Push Buttons

| Designator | Label | Description |
|------------|----------------------|---|
| S2 | PD Reset | This switch is a push-button that pulls the HRESET pin (44) of the TPS65987D device high when pressed. Releasing the push-button pulls HRESET low again, and the TPS65987D device goes through a soft reset, which consists of reloading firmware from RAM. If a valid configuration is present in RAM, the TPS65987D device will not reload configuration from the external flash. |
| S3 | Disable Flash Config | This push button switch will hold the SPI Miso line to GND. Use this button when booting the device. If this button is pressed when the device is booting, the TPS65987D device does not load its configuration from the SPI Flash and instead boots into a default ROM configuration. |

3 Using the TPS65987EVM

This section discusses how to power the EVM, configure the firmware, and how to debug.

3.1 Powering the TPS65987EVM

The main power supply for the EVM is the barrel jack (J9), which accepts 19 V to 20 V via a barrel jack adapter. The EVM can also be powered with an external power supply on SYS_PWR (pin 1 of J4, J5, or J6). The input voltage can range from 5 V to 20 V, but configure the appropriate power profile for PP_HV in the firmware using the configuration tool. The EVM can also be powered as a sink through a USB Type-C cable from a source adaptor, EVM, or device.

3.2 Firmware Configurations

Out of the box, the TPS65987EVM is configured to emulate a single port laptop computer. This configuration can be used to source or sink power known as (DRP), and this configuration sets DFP_D (Downward Facing Port). If different configurations are required to test your system, use the [TPS6598x configuration tool\(GUI\)](#) to create a configuration or load a different configuration template.

3.3 Debugging the EVM

The following checks can help resolve issues when connecting the EVM to another EVM or USB Type-C device and no status LEDs are on:

Make sure that a firmware image is loaded on the TPS65987EVM, using the [TPS6598x configuration tool\(GUI\)](#).

- Make sure the CC lines are toggling for dual-role port functionality.
- Make sure the following system supplies:
 - P3V3 = 3.3 V
 - P5V0 = 5 V
 - Barrel jack / SYS_PWR = 20 V (when plugged in)
 - VAR_DCDC = 5 V (when barrel jack is plugged in without a USB Type-C attached cable or device)
 - V_{BUS} = 5 V, 9 V, 15 V, or 20 V (when USB Type-C port is attached to another EVM or device)

4 Schematic and Bill of Materials

4.1 Schematic

Figure 4 to Figure 9 illustrate the TPS65987EVM schematics.

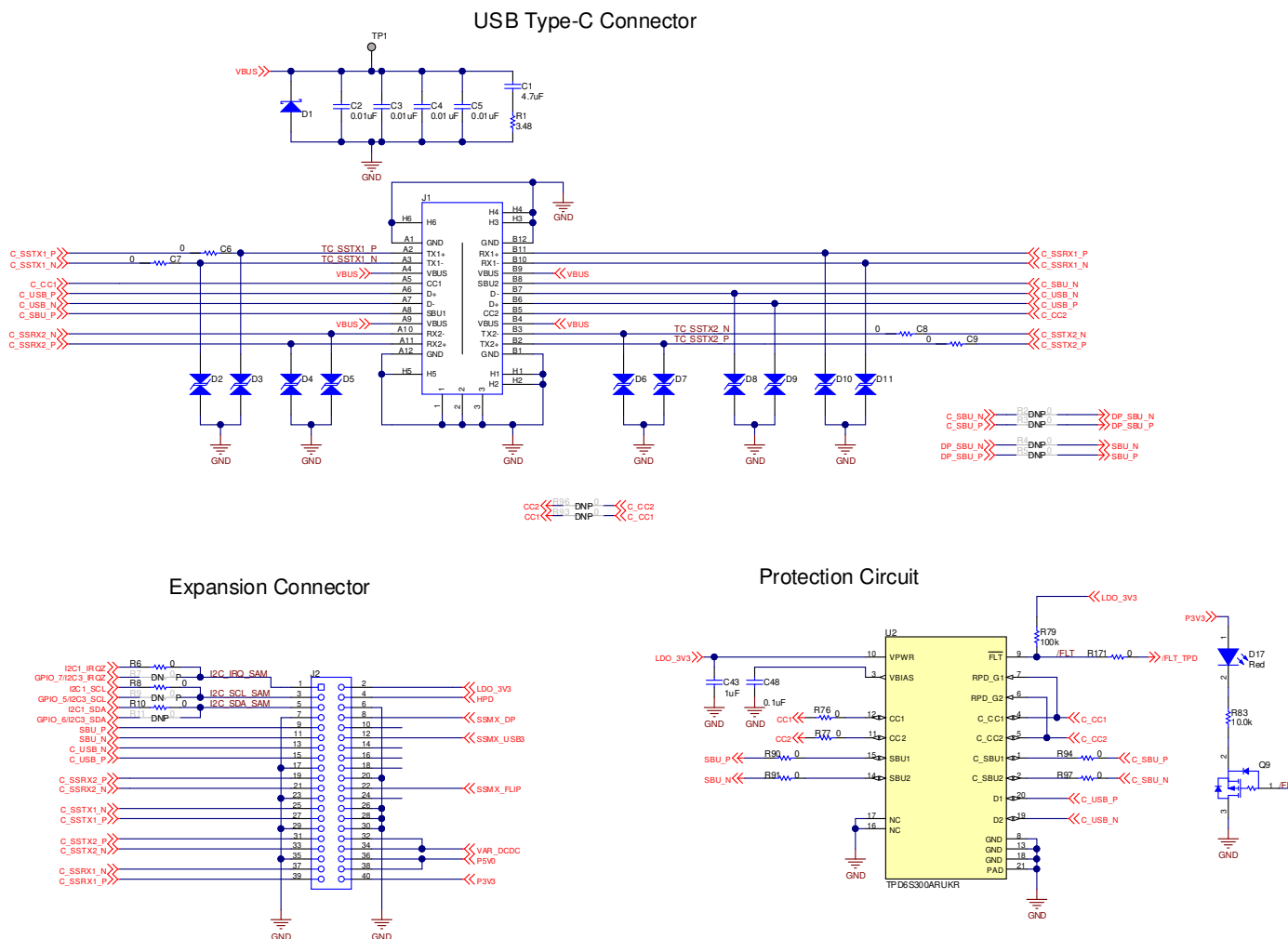
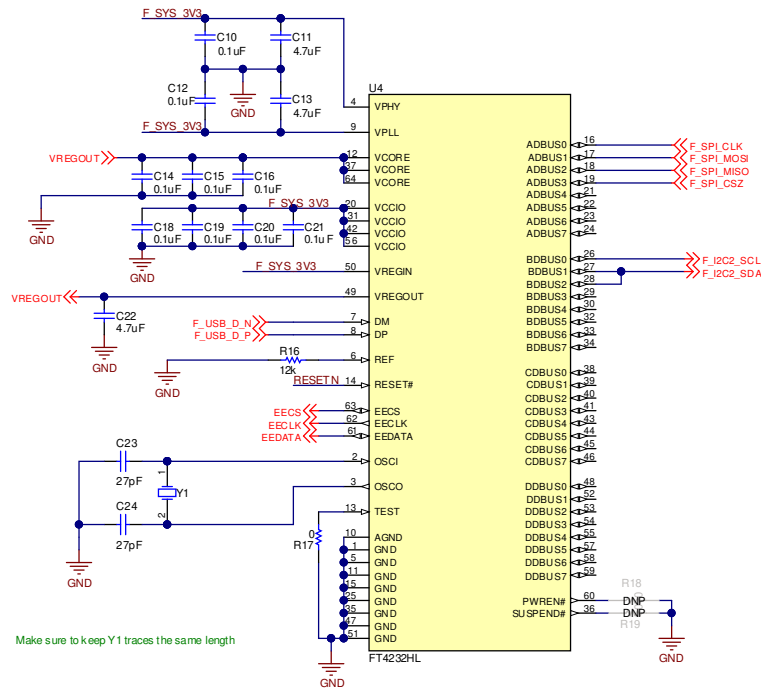


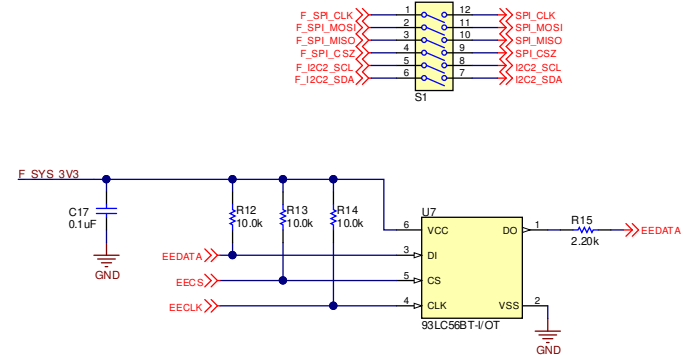
Figure 4. USB Type-C™ and External Module Connectors

FTDI Chip

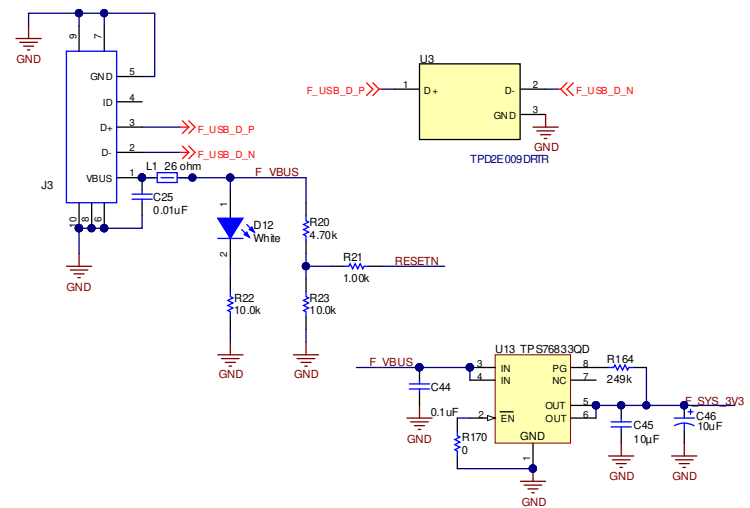


Make sure to keep Y1 traces the same length

FTDI Switches and Memory



Micro-B Connector



ULINK2 Debugger

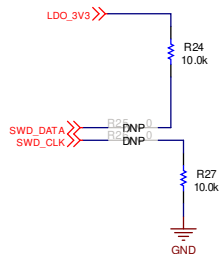
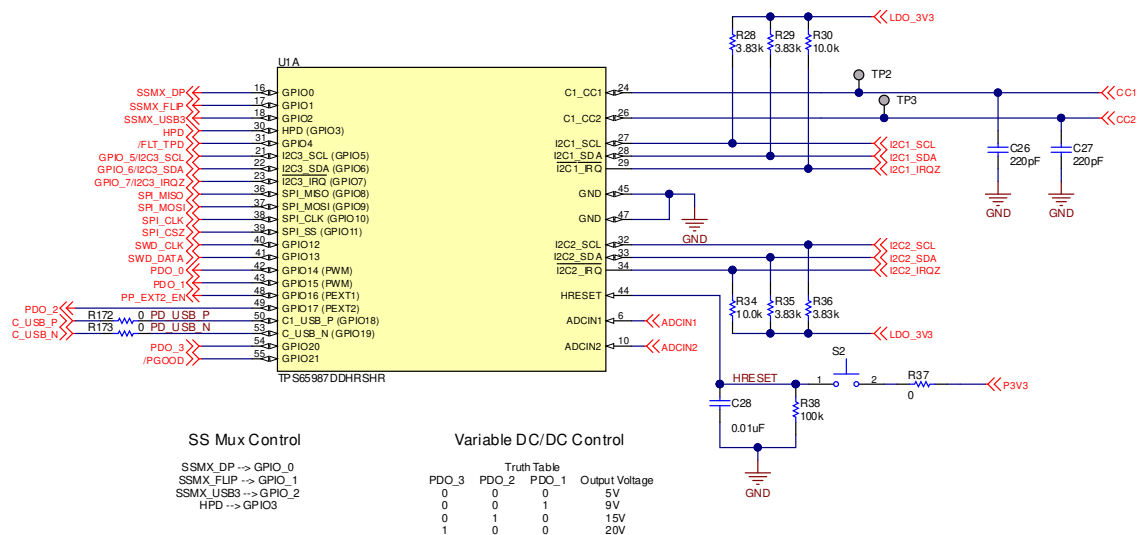
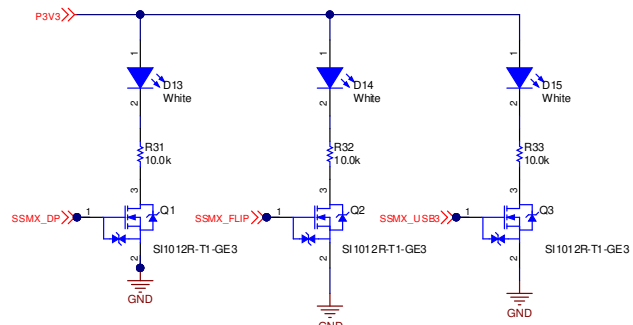


Figure 5. FTDI Device and Connector

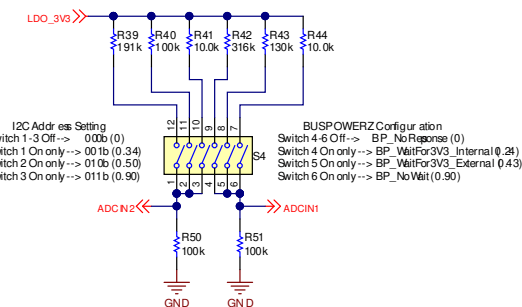
USB PD Controller



SS Mux Control LED's



ADCIN1:2 Resistor Divider Setting



EEPROM

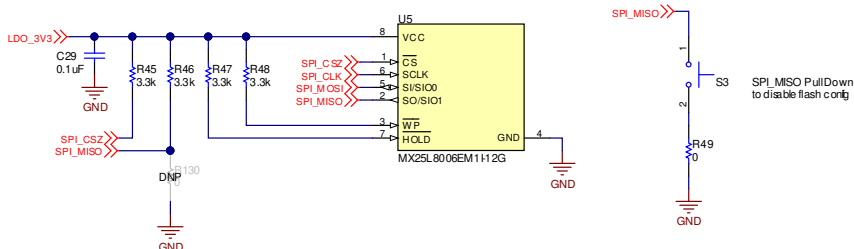
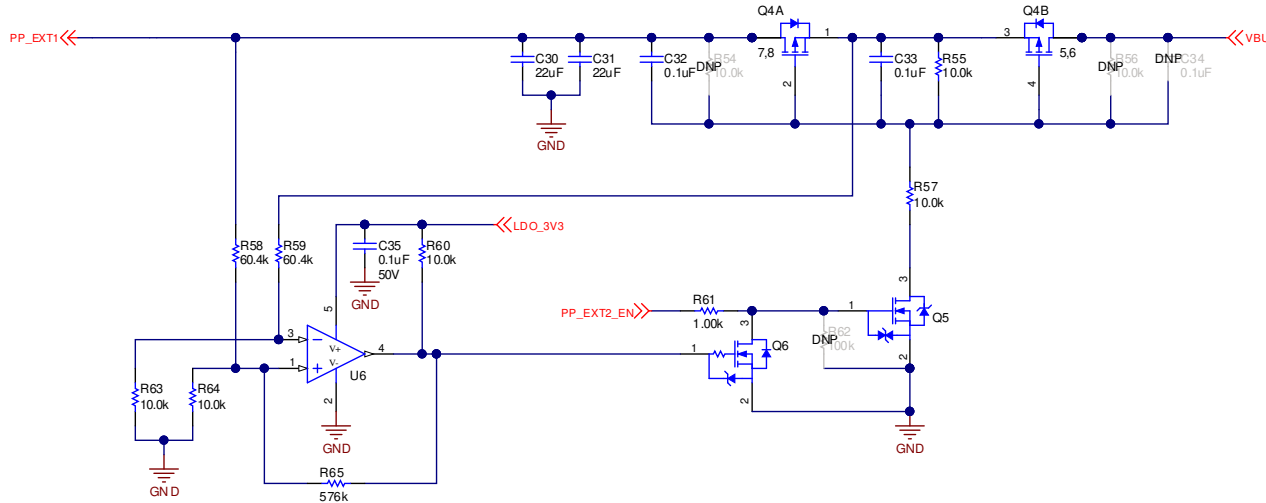
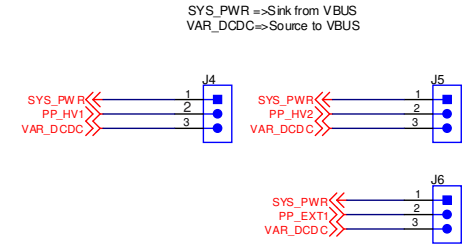


Figure 6. USB PD Controller and Memory

External Power Path (PD Controller)



PP Jumpers



USB PD Power Path

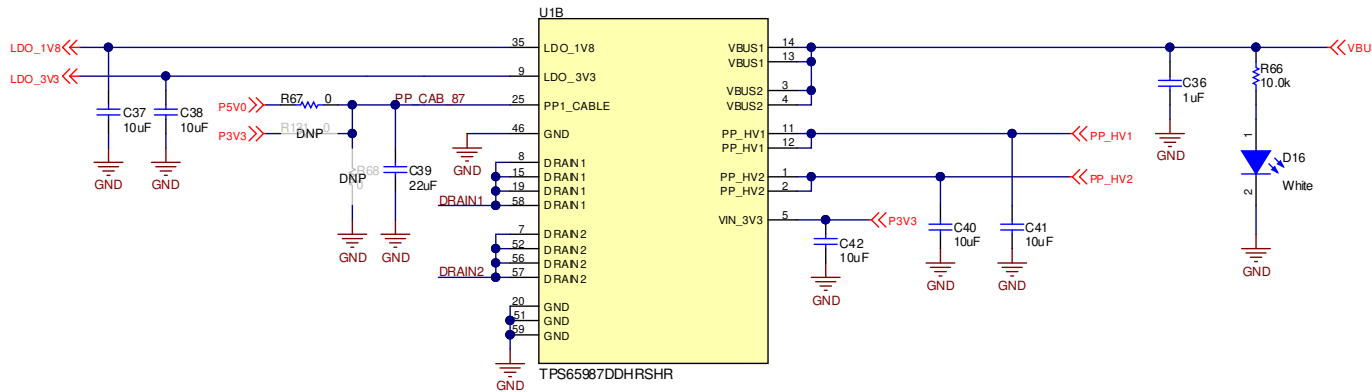
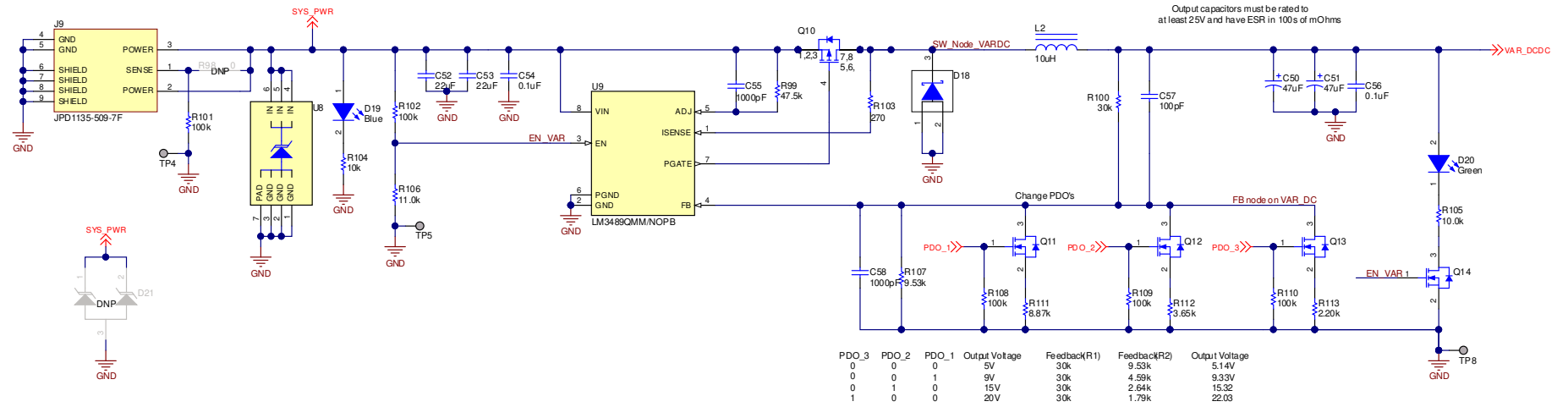
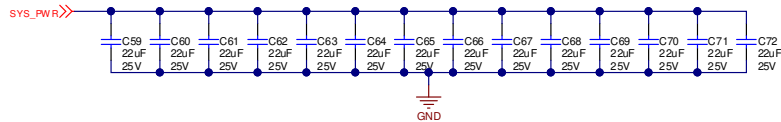


Figure 7. USB PD Power Paths

Variable DC/DC Converter: 5V, 9V, 15V, 20V



Fast Role Swap Caps



Var. DC/DC Control LED's

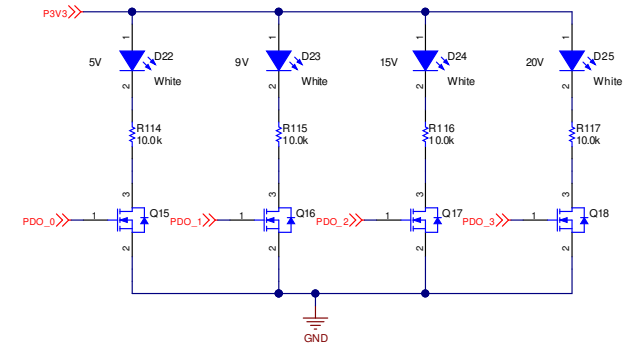
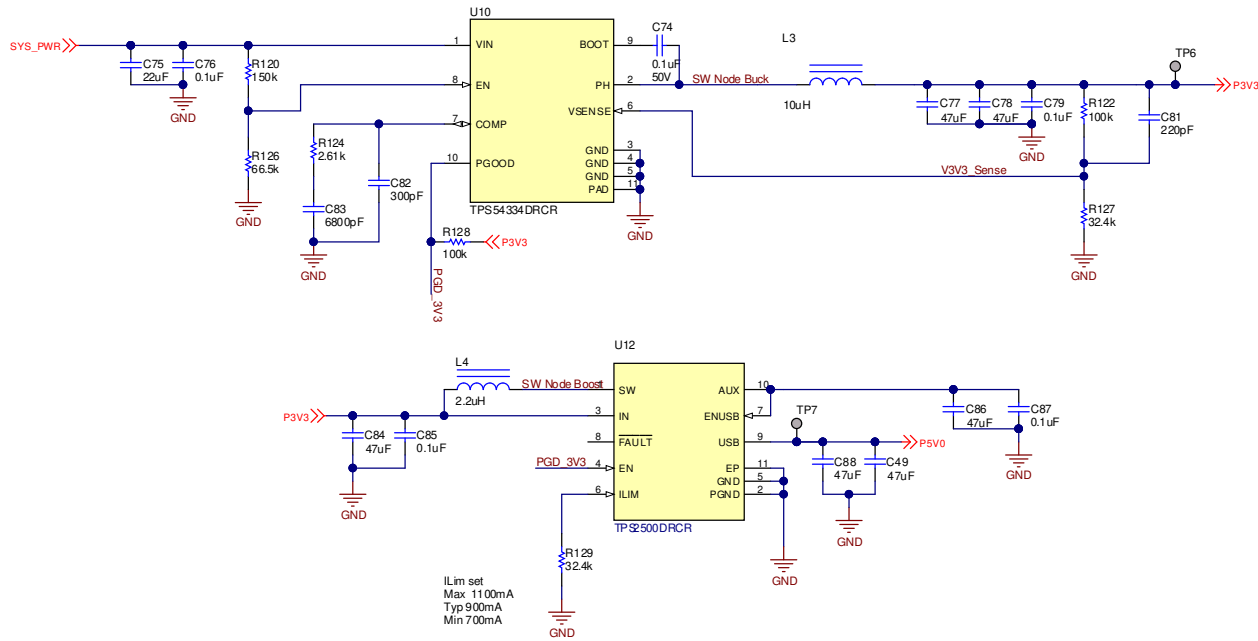


Figure 8. Variable DC/DC Controller

Buck Converter: SYS_PW R => 3.3V
&
Boost Converter: 3.3V => 5V



Barrel Jack Detection

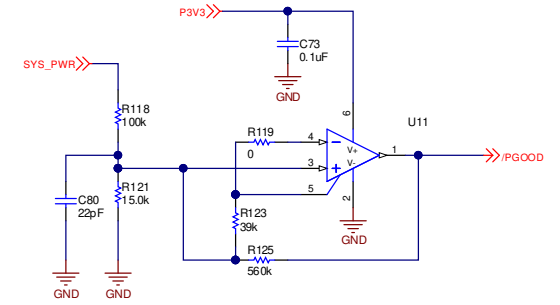


Figure 9. Buck and Boost DC/DC Converters

4.2 Bill of Materials

Table 8 lists the TPS65987EVM BOM.

Table 8. TPS65987EVM Bill of Materials

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|---|----------|---------|--|------------------|----------------------|---------------------------|---------------------------------|------------------------|
| !PCB1 | 1 | | Printed Circuit Board | | PSIL060 | Any | - | - |
| C1 | 1 | 4.7 uF | CAP, CERM, 4.7 μ F, 35 V, +/- 10%, X5R, 0603 | 0603 | GRM188R6YA475KE15D | MuRata | | |
| C2, C3, C4, C5, C28 | 5 | 0.01 uF | CAP, CERM, 0.01 μ F, 50 V, +/- 10%, C0G/NP0, 0402 | 0402 | GCM155R71H103KA55D | MuRata | | |
| C6, C7, C8, C9, R170 | 5 | 0 | RES, 0, 5%, .05 W, AEC-Q200 Grade 0, 0201 | 0201 | ERJ-1GN0R00C | Panasonic | | |
| C10, C12, C35, C44, C48, C74, C76, C79, C85, C87 | 10 | 0.1 uF | CAP, CERM, 0.1 uF, 50 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402 | 0402 | GCM155R71H104KE02D | MuRata | | |
| C11, C13, C22 | 3 | 4.7 uF | CAP, CERM, 4.7 uF, 10 V, +/- 20%, X5R, 0402 | 0402 | C1005X5R1A475M050BC | TDK | | |
| C14, C15, C16, C17, C18, C19, C20, C21 | 8 | 0.1 uF | CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402 | 0402 | CGA2B3X7R1H104K050BD | TDK | | |
| C23, C24 | 2 | 27 pF | CAP, CERM, 27 pF, 50 V, +/- 1%, C0G/NP0, 0603 | 0603 | CL10C270FB8NNNC | Samsung Electro-Mechanics | | |
| C25 | 1 | 0.01 uF | CAP, CERM, 0.01 μ F, 50 V, +/- 5%, X7R, 0402 | 0402 | C0402C103J5RACTU | Kemet | | |
| C26, C27 | 2 | 220 pF | CAP, CERM, 220 pF, 25 V, +/- 10%, X7R, 0201 | 0201 | GRM033R71E221KA01D | MuRata | | |
| C29 | 1 | 0.1 uF | CAP, CERM, 0.1 μ F, 16 V, +/- 10%, X7R, 0402 | 0402 | 885012205037 | Würth Elektronik | | |
| C30, C31, C52, C53, C59, C60, C61, C62, C63, C64, C65, C66, C67, C68, C69, C70, C71, C72, C75 | 19 | 22 uF | CAP, CERM, 22 μ F, 25 V, +/- 20%, X5R, 0805 | 0805 | GRM21BR61E226ME44L | MuRata | C2012X5R1V226M125 AC, [NoValue] | |
| C32, C33, C56, C73 | 4 | 0.1 uF | CAP, CERM, 0.1 μ F, 35 V, +/- 10%, X5R, 0402 | 0402 | GMK105BJ104KV-F | Taiyo Yuden | | |
| C36 | 1 | 1 uF | CAP, CERM, 1 μ F, 50 V, +/- 10%, X7R, 0603 | 0603 | UMK107AB7105KA-T | Taiyo Yuden | | |
| C37, C38, C42 | 3 | 10 uF | CAP, CERM, 10 μ F, 10 V, +/- 20%, X5R, 0402 | 0402 | CL05A106MP5NUNC | Samsung Electro-Mechanics | | |

Table 8. TPS65987EVM Bill of Materials (continued)

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|---|----------|---------|---|------------------|----------------------|-------------------|----------------------|------------------------|
| C39 | 1 | 22 uF | CAP, CERM, 22 μ F, 10 V, +/- 20%, X5R, 0603 | 0603 | C1608X5R1A226M080AC | TDK | | |
| C40, C41 | 2 | 10 uF | CAP, CERM, 10 μ F, 25 V, +/- 20%, X5R, 0603 | 0603 | GRM188R61E106MA73D | MuRata | | |
| C43 | 1 | 1 uF | CAP, CERM, 1 μ F, 16 V, +/- 10%, X5R, 0402 | 0402 | EMK105BJ105KVHF | Taiyo Yuden | | |
| C45 | 1 | 10 uF | CAP, CERM, 10 μ F, 10 V, +/- 20%, X5R, 0402 | 0402 | 0402ZD106MAT2A | AVX | | |
| C46 | 1 | 10 uF | CAP, TA, 10 uF, 10 V, +/- 10%, 2.5 ohm, SMD | 3528-21 | 293D106X9010B2TE3 | Vishay-Sprague | | |
| C49, C84, C86, C88 | 4 | 47 uF | CAP, CERM, 47 μ F, 6.3 V, +/- 20%, X5R, 0603 | 0603 | GRM188R60J476ME15D | MuRata | | |
| C50, C51 | 2 | 47 uF | CAP, TA, 47 μ F, 35 V, +/- 20%, 0.9 ohm, AEC-Q200 Grade 1, SMD | 7343-43 | TAJE476M035RNJ | AVX | | |
| C54 | 1 | 0.1 uF | CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X6S, 0402 | 0402 | C1005X7R1H104K050BB | TDK | | |
| C55, C58 | 2 | 1000 pF | CAP, CERM, 1000 pF, 50 V, +/- 20%, X7R, 0402 | 0402 | C1005X7R1H102M050BE | TDK | | |
| C57 | 1 | 100 pF | CAP, CERM, 100 pF, 50 V, +/- 10%, X7R, 0402 | 0402 | CC0402KRX7R9BB101 | Yageo America | | |
| C77, C78 | 2 | 47 uF | CAP, CERM, 47 μ F, 6.3 V, +/- 20%, X5R, 0805 | 0805 | GRM21BR60J476ME15L | MuRata | | |
| C80 | 1 | 22 pF | CAP, CERM, 22 pF, 50 V, +/- 5%, C0G/NP0, AEC-Q200 Grade 1, 0402 | 0402 | GCM1555C1H220JA16D | MuRata | | |
| C81 | 1 | 220 pF | CAP, CERM, 220 pF, 50 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0201 | 0201 | CGA1A2X7R1H221K030BA | TDK | | |
| C82 | 1 | 300 pF | CAP, CERM, 300 pF, 25 V, +/- 5%, C0G/NP0, 0402 | 0402 | C0402C301J3GAC7867 | Kemet | GCM1555C1H301JA16D | |
| C83 | 1 | 6800 pF | CAP, CERM, 6800 pF, 50 V, +/- 10%, X7R, 0402 | 0402 | GRM155R71H682KA88D | MuRata | | |
| D1 | 1 | 30 V | Diode, Schottky, 30 V, 2 A, 2-XFDFN | 2-XFDFN | NSR20F30NXT5G | ON Semiconductor | | |
| D2, D3, D4, D5, D6, D7, D8, D9, D10, D11 | 10 | | 1-Channel ESD Protection Diode for USB Type-C and Thunderbolt 3, DPL0002A (X2SON-2) | DPL0002A | TPD1E01B04DPLR | Texas Instruments | TPD1E01B04DPLT | Texas Instruments |
| D12, D13, D14, D15, D16, D22, D23, D24, D25 | 9 | White | LED, White, SMD | 0402, White | LW QH8G-Q2S2-3K5L-1 | OSRAM | LW QH8G-Q2OO-3K5L-1 | |
| D17 | 1 | Red | LED, Red, SMD | 0402 | APHHS1005SURCK | Kingbright | | |
| D18 | 1 | 40 V | Diode, Schottky, 40 V, 10 A, PowerDI5 | PowerDI5 | PDS1040L-13 | Diodes Inc. | | |
| D19 | 1 | Blue | LED, Blue, SMD | 1.6x0.8mm | LTST-C193TBKT-5A | Lite-On | | |
| D20 | 1 | Green | LED, Green, SMD | LED_0603 | 150060GS75000 | Würth Elektronik | | |

Table 8. TPS65987EVM Bill of Materials (continued)

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|-------------------------|----------|--------|--|---|-----------------------------|--------------------------|----------------------|------------------------|
| H1, H2, H3, H4 | 4 | | Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead | Screw | NY PMS 440 0025 PH | B&F Fastener Supply | | |
| H5, H6, H7, H8 | 4 | | Standoff, Hex, 0.5"L #4-40 Nylon | Standoff | 1902C | Keystone | | |
| J1 | 1 | | Connector, Receptacle, USB Type C, R/A, SMT | Connector, Receptacle, USB Type C, SMT | 20-0000016-01 | Lintes Technology | | |
| J2 | 1 | | Socket, 0.8mm, 20x2, Gold, SMT | Socket, 0.8mm, 20x2, Gold, SMT | LSEM-120-03.0-F-DV-A-N-K-TR | Samtec | | |
| J3 | 1 | | Connector, Receptacle, Micro-USB Type AB, R/A, Bottom Mount SMT | Connector, Receptacle, Micro-USB Type AB, R/A, Bottom Mount SMT | ZX62RD-AB-5P8(30) | Hirose Electric Co. Ltd. | ZX62RD-AB-5P8 | |
| J4, J5, J6 | 3 | | Header, 100mil, 3x1, Gold, TH | 3x1 Header | TSW-103-07-G-S | Samtec | | |
| J9 | 1 | | Connector, DC Power Jack, R/A, 3 Pos, TH | Power connector | JPD1135-509-7F | Foxconn | | |
| L1 | 1 | 26 ohm | Ferrite Bead, 26 ohm at 100 MHz, 6 A, 0603 | 0603 | BLM18SG260TN1D | MuRata | | |
| L2 | 1 | 10 uH | Inductor, Shielded, Powdered Iron, 10 uH, 7.5 A, 0.03 ohm, AEC-Q200 Grade 1, SMD | 11x10mm | SRP1038A-100M | Bourns | | |
| L3 | 1 | 10 uH | Inductor, Shielded, 10 uH, 4 A, 0.068 ohm, SMD | 7.2 mm x 6.65 mm | ASPI-0630LR-100M-T15 | Abracon Corporation | - | - |
| L4 | 1 | 2.2 uH | Inductor, Shielded, Powdered Iron, 2.2 uH, 4.7 A, 0.035 ohm, AEC-Q200 Grade 1, SMD | 4.1x4.1mm | 78438356022 | Würth Elektronik | | |
| Q1, Q2, Q3 | 3 | 20 V | MOSFET, N-CH, 20 V, 0.6 A, SOT-416 | SOT-416 | SI1012R-T1-GE3 | Vishay-Siliconix | | None |
| Q4 | 1 | -30 V | MOSFET, 2-CH, P-CH, -30 V, -60 A, 610x604x515mm | 610x604x515mm | SI7997DP-T1-GE3 | Vishay-Siliconix | | None |
| Q5 | 1 | 30 V | MOSFET, N-CH, 30 V, 0.35 A, AEC-Q101, SOT-323 | SOT-323 | NX3008NBKW,115 | Nexperia | | None |
| Q6 | 1 | 20 V | MOSFET, N-CH, 20 V, 0.5 A, YJM0003A (PICOSTAR-3) | YJM0003A | CSD15380F3 | Texas Instruments | | None |
| Q9 | 1 | -20 V | MOSFET, P-CH, -20 V, -0.76 A, SOT-416 | SOT-416 | NTA4151PT1G | ON Semiconductor | | None |
| Q10 | 1 | -30V | MOSFET, P-CH, -30 V, -11 A, FET, 3x0.8x3mm | FET, 3x0.8x3mm | AON7403 | AOS | | None |
| Q11, Q12, Q13 | 3 | 20 V | MOSFET, N-CH, 20 V, 1.05 A, SOT-23 | SOT-23 | BSH105,215 | Nexperia | | None |
| Q14, Q15, Q16, Q17, Q18 | 5 | 30 V | MOSFET, N-CH, 30 V, 0.18 A, SOT-323 | SOT-323 | NX3020NAKW,115 | Nexperia | | None |
| R1 | 1 | 3.48 | RES, 3.48, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04023R48FKED | Vishay-Dale | | |

Table 8. TPS65987EVM Bill of Materials (continued)

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|---|----------|--------|--|------------------|-------------------|---------------|----------------------|------------------------|
| R6, R8, R10 | 3 | 0 | RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0402 | 0402 | ERJ-2GE0R00X | Panasonic | | |
| R12, R13, R14, R22, R23, R30, R32, R33, R34, R41, R44, R55, R57, R60, R63, R64, R66, R105, R114, R115, R116, R117 | 23 | 10.0 k | RES, 10.0 k, 1%, 0.1 W, 0402 | 0402 | ERJ-2RKF1002X | Panasonic | | |
| R15 | 1 | 2.20 k | RES, 2.20 k, 1%, 0.063 W, 0402 | 0402 | RC0402FR-072K2L | Yageo America | | |
| R16 | 1 | 12 k | RES, 12 k, 5%, 0.063 W, 0402 | 0402 | CRCW040212K0JNED | Vishay-Dale | | |
| R17, R119 | 2 | 0 | RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04020000Z0ED | Vishay-Dale | | |
| R20 | 1 | 4.70 k | RES, 4.70 k, 1%, 0.1 W, 0402 | 0402 | ERJ-2RKF4701X | Panasonic | | |
| R21, R61 | 2 | 1.00 k | RES, 1.00 k, 1%, 0.1 W, 0402 | 0402 | ERJ-2RKF1001X | Panasonic | | |
| R24, R27 | 2 | 10.0 k | RES, 10.0 k, 1%, 0.1 W, 0603 | 0603 | RC0603FR-0710KL | Yageo | | |
| R28, R29, R35, R36 | 4 | 3.83 k | RES, 3.83 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04023K83FKED | Vishay-Dale | | |
| R31 | 1 | 10.0 k | RES, 10.0 k, 0.5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040210K0DHEDP | Vishay-Dale | | |
| R37, R49, R67, R76, R77 | 5 | 0 | RES, 0, 5%, 0.063 W, 0402 | 0402 | RC0402JR-070RL | Yageo America | | |
| R38, R40, R50, R51, R101, R102, R108, R109, R110, R118, R122, R128 | 12 | 100 k | RES, 100 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402100KFKED | Vishay-Dale | | |
| R39 | 1 | 191 k | RES, 191 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402191KFKED | Vishay-Dale | | |
| R42 | 1 | 316 k | RES, 316 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402316KFKED | Vishay-Dale | | |
| R43 | 1 | 130 k | RES, 130 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402130KFKED | Vishay-Dale | | |
| R45, R46, R47, R48 | 4 | 3.3 k | RES, 3.3 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04023K30JNED | Vishay-Dale | | |
| R58, R59 | 2 | 60.4 k | RES, 60.4 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040260K4FKED | Vishay-Dale | | |
| R65 | 1 | 576 k | RES, 576 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402576KFKED | Vishay-Dale | | |
| R79 | 1 | 100 k | RES, 100 k, 5%, 0.05 W, 0201 | 0201 | RC0201JR-7D100KL | Yageo America | | |

Table 8. TPS65987EVM Bill of Materials (continued)

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|---|----------|--------|---|------------------|------------------|--------------------------------|----------------------|------------------------|
| R83 | 1 | 10.0 k | RES, 10.0 k, 1%, 0.063 W, 0402 | 0402 | RC0402FR-0710KL | Yageo America | | |
| R90, R91, R94, R97, R171, R172, R173 | 7 | 0 | RES, 0, 5%, 0.05 W, 0201 | 0201 | CRCW02010000Z0ED | Vishay-Dale | | |
| R99 | 1 | 47.5 k | RES, 47.5 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040247K5FKED | Vishay-Dale | | |
| R100 | 1 | 30 k | RES, 30 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040230K0JNED | Vishay-Dale | | |
| R103 | 1 | 270 | RES, 270, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402270RJNED | Vishay-Dale | | |
| R104 | 1 | 10 k | RES, 10 k, 5%, 0.1 W, 0603 | 0603 | RC0603JR-0710KL | Yageo | | |
| R106 | 1 | 11.0 k | RES, 11.0 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040211K0FKED | Vishay-Dale | | |
| R107 | 1 | 9.53 k | RES, 9.53 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04029K53FKED | Vishay-Dale | | |
| R111 | 1 | 8.87 k | RES, 8.87 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04028K87FKED | Vishay-Dale | | |
| R112 | 1 | 3.65 k | RES, 3.65 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04023K65FKED | Vishay-Dale | | |
| R113 | 1 | 2.20 k | RES, 2.20 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04022K20FKED | Vishay-Dale | | |
| R120 | 1 | 150 k | RES, 150 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402150KFKED | Vishay-Dale | | |
| R121 | 1 | 15.0 k | RES, 15.0 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040215K0FKED | Vishay-Dale | | |
| R123 | 1 | 39 k | RES, 39 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040239K0JNED | Vishay-Dale | | |
| R124 | 1 | 2.61 k | RES, 2.61 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04022K61FKED | Vishay-Dale | | |
| R125 | 1 | 560 k | RES, 560 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402560KJNED | Vishay-Dale | | |
| R126 | 1 | 66.5 k | RES, 66.5 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040266K5FKED | Vishay-Dale | | |
| R127, R129 | 2 | 32.4 k | RES, 32.4 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040232K4FKED | Vishay-Dale | | |
| R164 | 1 | 249 k | RES, 249 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW0603249KFKEA | Vishay-Dale | | |
| S1, S4 | 2 | | DIP Switch, SPST, 6Pos, Slide, SMT | 8.75x6.2mm | TDA06H0SB1 | C&K Components | | |
| S2, S3 | 2 | | SWITCH TACTILE SPST-NO 0.05-A ,12 V | 3x1.6x2.5mm | B3U-1000P | Omron Electronic Components | | |
| SH-J1, SH-J2 | 2 | 1x2 | Shunt, 100mil, Gold plated, Black | Shunt | SNT-100-BK-G | Samtec | 969102-0000-DA | 3M |

Table 8. TPS65987EVM Bill of Materials (continued)

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|--|----------|--------|--|----------------------------|-------------------|---------------------------------|----------------------|------------------------|
| TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8 | 7 | | Test Point, Miniature, SMT | Test Point, Miniature, SMT | 5019 | Keystone | | |
| U1 | 1 | | USB Type-C and USB PD Controller with Integrated Power Switches, RSH0056E (VQFN-56) | RSH0056E | TPS65987DDHRSHR | Texas Instruments | TPS65987DDHRSHR | Texas Instruments |
| U2 | 1 | | USB Type-C Port Protector: Short-to-VBUS Overvoltage and IEC ESD Protection, RUK0020B (WQFN-20) | RUK0020B | TPD6S300ARUKR | Texas Instruments | | Texas Instruments |
| U3 | 1 | | ESD Protection Array for High-Speed Data Interfaces, 2 Channels, -40 to +85 degC, 3-pin SOT (DRT), Green (RoHS & no Sb/Br) | DRT0003A | TPD2E009DRTR | Texas Instruments | | |
| U4 | 1 | | Quad High Speed USB to Multipurpose UART/MPSSE IC | LQFP_10x10mm | FT4232HL | FTDI | | |
| U5 | 1 | | 8Mb, 86MHz, NOR Flash, SOP-8 | 8-SOP | MX25L8006EM11-12G | Macronix International Co., LTD | | |
| U6 | 1 | | 2.2-V to 36-V, microPower Comparator, DBV0005A (SOT-23-5) | DBV0005A | TLV1701AIDBVR | Texas Instruments | TLV1701AIDBVT | Texas Instruments |
| U7 | 1 | | 2K Microwire Compatible Serial EEPROM, SOT-23-6 | SOT-23-6 | 93LC56B-I/OT | Microchip | 93LC56BT-I/OT | |
| U8 | 1 | | 22-V Precision Surge Protection Clamp, DRV0006A (WSON-6) | DRV0006A | TVS2200DRVR | Texas Instruments | | Texas Instruments |
| U9 | 1 | | Automotive Grade 4.5-35 V, Hysteretic Non-Synchronous PFET Buck Controller with Enable Pin, DGK0008A (VSSOP-8) | DGK0008A | LM3489QMM/NOPB | Texas Instruments | | Texas Instruments |
| U10 | 1 | | 4.2-V to 28-V Input voltage, 3-A Output current Synchronous buck Converter with 570kHz fixed frequency, DRC0010J (VSON-10) | DRC0010J | TPS54334DRCR | Texas Instruments | TPS54334DRCT | Texas Instruments |
| U11 | 1 | | Nanopower, 1.8 V, SOT23 Push-Pull Comparator with Voltage Reference, DCK0006A (SOT-SC70-6) | DCK0006A | TLV3012AIDCKR | Texas Instruments | TLV3012AIDCKT | Texas Instruments |
| U12 | 1 | | Integrated USB Power Switch with Boost Converter, DRC0010J (VSON-10) | DRC0010J | TPS2500DRCR | Texas Instruments | | |
| U13 | 1 | | Single Output Fast Transient Response LDO, 1 A, Fixed 3.3 V Output, 2.7 to 10 V Input, with Low IQ, 8-pin SOIC (D), -40 to 125 degC, Green (RoHS & no Sb/Br) | D0008A | TPS76833QD | Texas Instruments | | |
| Y1 | 1 | | CRYSTAL, 12 MHz, 20 pF, SMD | 7x2.3x4.1mm | ECS-120-20-3X-TR | ECS Inc. | | |
| C34 | 0 | 0.1 uF | CAP, CERM, 0.1 uF, 35 V, +/- 10%, X5R, 0402 | 0402 | GMK105BJ104KV-F | Taiyo Yuden | | |
| D21 | 0 | 24 V | Diode, TVS, Uni, 24 V, 70 Vc, SOT-23 | SOT-23 | PESD24VS2UT,215 | Nexperia | | |

Table 8. TPS65987EVM Bill of Materials (continued)

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|------------------------------------|----------|--------|--|------------------|------------------|---------------|----------------------|------------------------|
| FID1, FID2, FID3, FID4, FID5, FID6 | 0 | | Fiducial mark. There is nothing to buy or mount. | N/A | N/A | N/A | | |
| R2, R3, R4, R5 | 0 | 0 | RES, 0, 5%, 0.05 W, 0201 | 0201 | CRCW02010000Z0ED | Vishay-Dale | | |
| R7, R9, R11 | 0 | 0 | RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0402 | 0402 | ERJ-2GE0R00X | Panasonic | | |
| R18, R19 | 0 | 0 | RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04020000Z0ED | Vishay-Dale | | |
| R25, R26 | 0 | 0 | RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06030000Z0EA | Vishay-Dale | | |
| R54, R56 | 0 | 10.0 k | RES, 100 k, 1%, 0.063 W, 0402 | 0402 | ERJ-2RKF1002X | Panasonic | | |
| R62 | 0 | 100 k | RES, 100 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402100KFKED | Vishay-Dale | | |
| R68, R93, R96, R130, R131 | 0 | 0 | RES, 0, 5%, 0.063 W, 0402 | 0402 | RC0402JR-070RL | Yageo America | | |
| R98 | 0 | 0 | RES, 0, 5%, 0.125 W, AEC-Q200 Grade 0, 0805 | 0805 | ERJ-6GEY0R00V | Panasonic | | |

Revision History

| Changes from Original (April 2019) to A Revision | Page |
|--|------|
| • Updated Section 1.1 | 3 |
| • Updated Table 1 | 4 |
| • Updated Table 2 | 5 |
| • Updated Table 4 | 5 |
| • Updated Section 3.2 | 7 |
| • Updated Figure 4 title. | 8 |

STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
2. *Limited Warranty and Related Remedies/Disclaimers:*
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGRADATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。日本テキサス・インスツルメンツ株式会社
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3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。
http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_02.page

3.4 European Union

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

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- 4 *EVM Use Restrictions and Warnings:*
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 *Safety-Related Warnings and Restrictions:*
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
 5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.
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